

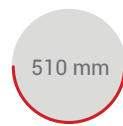
GAP-251R - G6 Series 2U RUGGED WORKSTATION



Intel® Xeon® E3-1200 v5/v6, 6th/7th Gen. Intel® Core™ i3 series - Kaby Lake / Sky Lake
Rear I/O - Rear Power Supply



Platform



Depth



CPU



RAM



SSD



I/O Boards

GAP is a line of rugged servers and workstations with an aluminum construction, designed for applications that require robust and qualified MIL-GRADE equipment, suitable for operations in critical environments.

GAP-251R G6 workstations feature a single socket Intel® Xeon® E3-1200 v5/v6, 6th/7th Gen. Intel® Core™ i3 series (Kaby Lake / Sky Lake) processors supporting up to 4 Cores (8 thread with Hyper-Threading), 8MB Smart Cache, up to 64GB DDR4 memory with or without ECC and up to 16 PCIe 3.0 lanes. The integrated IPMI services support monitoring, control, and management functions sending alarm notifications in case of critical events.

GAP-251R are designed for 19" rackmounting and have a 2U chassis with a depth of 510mm.

The rear I/O and rear power supply layout includes twelve removable SSDs and an optional slim DVD.

GAP-251R rugged workstations can host one low profile PCIe card and two PCIe cards.

In case additional boards are needed they can be provided with dedicated fixings for an optimal protection against shocks and vibrations also during transport.

GAP workstations are designed to meet MIL-STD-810F for temperature and shocks, MIL-STD-167-1A for vibrations. Optionally, they can conform to MIL-STD-461 for EMI /EMC.

The I/O connectors and the power supply input can be provided with MIL-GRADE connectors upon request.

All units are delivered with their inventory list to ensure configuration control and reproducibility over time. Upon request, all server configurations can run specific thermal or mechanical environmental stress test.

FEATURES

- 2U Rugged Workstation - 510mm depth
- Intel® Xeon® E3-1200 v5/v6 series
- 6th/7th Gen. Intel® Core™ i3 series
- Rear I/O connectors
- Rear Power Input
- Redundant AC or DC Power Supply
- Up to 12 removable 2.5" SSD
- Optional DVD
- Up to 3 PCIe boards
- Optional Conformal Coating
- MIL-STD-810G
- Optional MIL-STD-461

Technical Specifications

System

Processor	Intel® Xeon® E3-1200 v5/v6, 6th/7th Gen. Intel® Core™ i3 - single socket H4 (LGA 1151)
Memory	Up to 64GB ECC UDIMM, DDR4-2400MHz
Chipset	Intel® C236
Network	2 x RJ45 Gigabit Ethernet 1 x RJ45 dedicated IPMI
Storage	2.5" SATA Disk - RAID 0, 1, 5, 10
SATA	6 SATA3 ports (6Gbps); RAID 0, 1, 5, 10
TPM	1 TPM Header
Motherboard I/O	Available at the rear: 1 x VGA, 2 x USB 2.0, 2 x USB 3.0, 1 x COM, 2 x LAN, 1 x IPMI
Expansion slots	2x PCIe - Bracket Full Height 1x PCIe - Low Profile
Operative Systems	Windows® 7, Windows® 8.1, Windows® 10 IoT Enterprise 2016, Windows® Server 2008 R2, Windows® Server 2012 R2, Hyper-V Server 2012 R2, Linux
IPMI	IPMI2.0, SPM, Watchdog; SNMP and e-mail alarms and notifications
Monitoring	Monitoring, control, and management functions (fan speed, temperature, voltage, redundant power failure, power consumption, disk health, raid health, and memory health)

Power Supply

Power Supply	100/240 Redundant VAC 18-36 Single or Redundant VDC 36-72 Single or Redundant VDC
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Mechanical

Dimensions	483 x 88 x 510 mm
Construction	Aluminum with surface passivation treatment
Colour	Silver / RAL9007
Mounting	2U 19" rackmount chassis Optional telescopic slides
Configuration	Rear I/O and Power Supply
Front Panel	Led Power ON and HDD/SSD functionality; Power ON / OFF and System Reset; 2 x USB 2.0
Drive Bay	1 x slim 5.25"; 4 x 3.5" bay + 1 x internal bay x 3 ODD 2.5"

Environmental - (Design to meet)

Operating Temperature	Standard: 0°C / +50°C Extended: -20°C / +60°C (depending on the configurations)
Operating Humidity	8% to 95% non-condensed (depending on the configurations)
Storage Temperature	-40°C / +70°C
Operating Vibration	MIL-STD-167-1A, Type I
Operating Shock	MIL-STD-810G Proc. I Method 516.7 - 15g / 11ms – half sine
Transport Shock	MIL-STD-810G Proc. II Method 516.7 - 30g / 9ms sawtooth
Certifications	Directive 2014/35/UE-LVD / Directive 2014/30/UE-EMC Directive 2011/65/UE - RoHS / Regulation (EC) No 1907/2006 - REACH

GAP servers and workstations are designed in accordance with the environmental specifications indicated. Some parameters depend on the configuration. Equipment may be subjected to dedicated test profiles.